

# PRODUCT DATASHEET

Rev 0.2

## CGY2107HV

### Dual High Gain Low Noise High IP3 Amplifier

#### DESCRIPTION

The CGY2107HV is an extremely Low Noise cascode Amplifier with state of the art Noise Figure and Linearity suitable for applications from 500 MHz to 6 000 MHz.

The CGY2107HV consists of two identical amplifiers on the same MMIC, and is ideal for use in a balanced configuration or as two single ended amplifiers. Used as a balanced amplifier with 3 dB couplers, a 0.63 dB Noise Figure, 34 dBm Output IP3 and 23.5 dB Gain is obtained at 1.9 GHz. At 3.5 GHz a balanced demonstrator exhibits 0.85 dB Noise Figure, 19.5 dB Gain and OIP3 of 37 dBm. These are measured values and include the noise contribution of the couplers, connectors and biasing circuitry. The minimum Noise Figure of the CGY2107HV itself is 0.32 dB at 1.9 GHz.

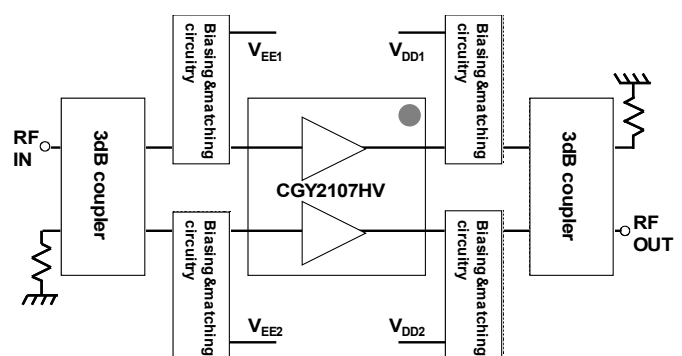
The MMIC is manufactured using OMMIC's qualified 0.25  $\mu\text{m}$  PHEMT GaAs MMIC technology. The device is available in a 4x4 mm QFN plastic package.

#### APPLICATIONS

- ▶ High performance LNA in the band 0.5 – 6 GHz
- ▶ Base Station applications (LTE, GSM, CDMA, WCDMA, TD-SCDMA, CDMA2000, WiMAX, etc)
- ▶ Tower mounted amplifiers
- ▶ Repeaters

#### FEATURES

- ▶ Usable frequency range from 500 MHz to 6000 MHz
- ▶ Dual MMIC LNA with excellent tracking
- ▶ Amplifier **NFmin@1.9GHz = 0.32 dB**
- ▶ Low Noise, High Gain and high IP3 in balanced configuration :  
**NF=0.63 dB, Gain=23.5 dB, OIP3=34 dBm @ 1.9 GHz**  
**NF=0.7 dB, Gain=21 dB, OIP3=33 dBm @ 2.5 GHz**  
**NF=0.85 dB, Gain=19.5 dB, OIP3=37 dBm @ 3.5 GHz**
- ▶ Uses a highly reliable PHEMT MMIC process
- ▶ Delivered as 100 % RF tested devices
- ▶ Samples and Demonstration Boards Available
- ▶ Space and MIL-STD Available



*Schematic diagram of the CGY2107HV used in a balanced configuration.*



**The CGY2107HV is RoHS compliant.**

## LIMITING VALUES

$T_{amb} = +23\text{ }^{\circ}\text{C}$ , at QFN package lead; unless otherwise specified.

Symbol	Parameter	Conditions	MIN.	MAX.	UNIT
$V_{EE1}, V_{EE2}$	Gate voltage	$V_{DD}$ open-circuited	-3	+1	V
$V_{DD1}, V_{DD2}$	Drain voltage	$V_{EE}$ open-circuited	-1	+10	V
$I_{D1}, I_{D2}$	Drain current			100	mA
$P_{IN}$	Input power			10	dBm
$T_{amb}$	Ambient temperature		-40	+85	$^{\circ}\text{C}$
$T_j$	Junction temperature			+150	$^{\circ}\text{C}$
$T_{stg}$	Storage temperature		-55	+150	$^{\circ}\text{C}$

## THERMAL CHARACTERISTICS

Symbol	Parameter	Value	UNIT
$R_{th(j-a)}$	Thermal resistance from junction to ambient ( $T_a = 25\text{ }^{\circ}\text{C}$ )	70	$^{\circ}\text{C/W}$

## CHARACTERISTICS

$T_{amb} = +23\text{ }^{\circ}\text{C}$

Symbol	Parameter	Conditions	MIN.	TYP.	MAX.	UNIT
$f_i$	Input frequency		0.5		6	GHz
<i>Performance at QFN package lead; <math>f_i = 1.9\text{ GHz}</math></i>						
$V_D$	Supply voltage			4		V
$I_D$	Supply current	$V_{EE} = -0.55\text{ V}$		50		mA
G	Gain			22.7		dB
$NF_{min}$	Minimum Noise Figure			0.32		dB
<i>Performance * of Reference Board (Single Ended configuration with on-board bias resistors); <math>f_i = 1.95\text{ GHz}</math></i>						
$V_{DD}$	Supply voltage			5		V
$I_D$	Supply current	$V_{EE1} = V_{EE2} = -0.55\text{ V}$		50		mA
G	Gain		23	24		dB
NF	Noise Figure			0.5		dB
$ISO_{rev}$	Reverse Isolation	OUT/IN		32		dB
IIP3	Input third order intercept point	$I_D = 70\text{ mA}$	3.5	7		dBm
$S_{11}$	Input reflection coefficient	50 $\Omega$ source		-4.5		dB
$S_{22}$	Output reflection coefficient	50 $\Omega$ load		-10		dB
$ISO_{IN1-IN2}$	Isolation between IN1 and IN2	IN1/IN2	30			dB
<i>Performance * of Demonstration Board (Balanced configuration with on-board bias resistors); <math>f_i = 1.9\text{ GHz}</math></i>						
$V_{DD1}, V_{DD2}$	Supply voltage			5		V
$I_{D1}, I_{D2}$	Supply current	$V_{EE1} = V_{EE2} = -0.66\text{ V}$		50		mA
G	Gain			23.4		dB
NF	Noise Figure			0.63		dB
IIP3	Input third order intercept point			11		dBm
$P_{1dB}$	Output Power @ 1dB gain compression			22		dBm
$S_{11}$	Input reflection coefficient	50 $\Omega$ source		-25.6		dB
$S_{22}$	Output reflection coefficient	50 $\Omega$ load		-23.9		dB

(\*) Measurement reference planes are the INPUT and OUTPUT SMA connectors.

**Caution :** This device is a high performance RF component and can be damaged by inappropriate handling. Standard ESD precautions should be followed. OMMIC document "OM-CI-MV/ 001/ PG" contains more information on the precautions to take.

**S-PARAMETERS**
 $V_D = 4\text{ V}; I_D = 50\text{ mA}; T_{\text{amb}} = +23\text{ }^\circ\text{C}$ 

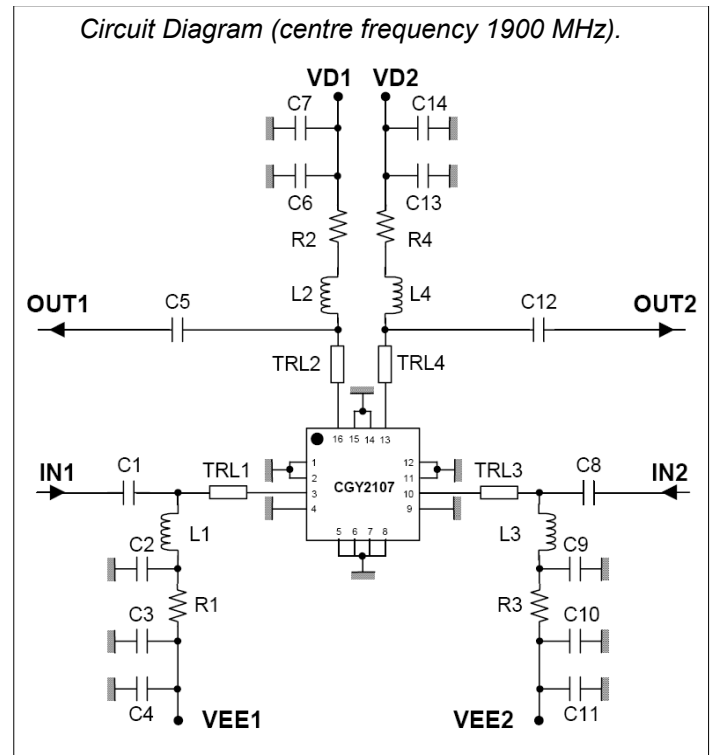
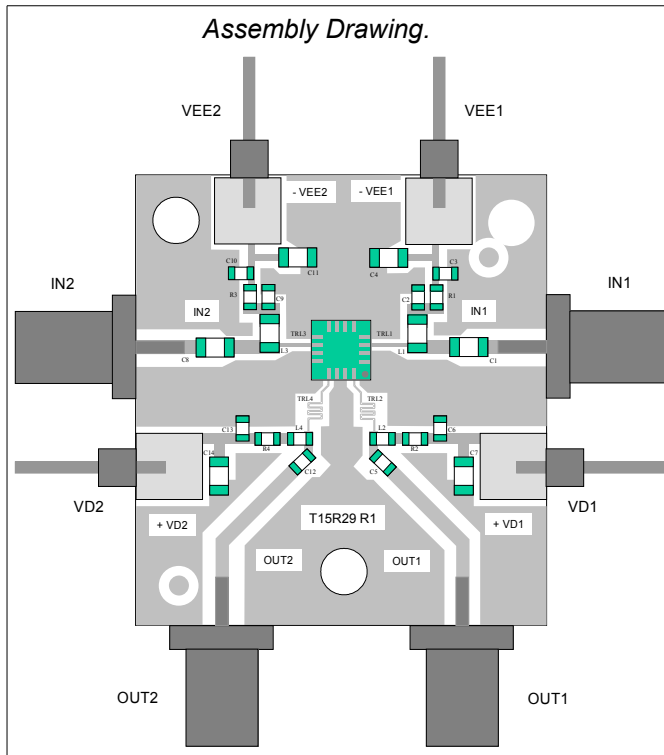
Frequency (GHz)	S11	Ang S11 (°)	S21	Ang S21 (°)	S12	Ang S12 (°)	S22	Ang S22 (°)
0.1	-0.40	-6.74	27.29	179.05	-51.76	34.78	-3.38	10.85
0.2	-0.49	-13.03	27.48	170.31	-49.24	44.75	-2.86	1.85
0.3	-0.61	-19.28	27.41	163.03	-47.09	50.59	-2.79	-3.36
0.4	-0.77	-25.39	27.26	156.37	-45.28	53.31	-2.80	-7.36
0.5	-0.97	-31.32	27.05	150.10	-43.78	54.23	-2.86	-10.79
0.6	-1.19	-37.03	26.81	144.15	-42.53	54.14	-2.93	-13.89
0.7	-1.44	-42.52	26.54	138.49	-41.47	53.47	-3.01	-16.77
0.8	-1.71	-47.77	26.24	133.09	-40.56	52.47	-3.09	-19.48
0.9	-1.98	-52.78	25.93	127.95	-39.77	51.28	-3.18	-22.07
1	-2.27	-57.56	25.61	123.05	-39.07	49.99	-3.27	-24.56
1.1	-2.55	-62.12	25.28	118.37	-38.45	48.65	-3.36	-26.98
1.2	-2.84	-66.46	24.94	113.90	-37.90	47.30	-3.44	-29.34
1.3	-3.13	-70.61	24.61	109.61	-37.39	45.93	-3.53	-31.66
1.4	-3.40	-74.58	24.27	105.51	-36.92	44.57	-3.61	-33.96
1.5	-3.68	-78.37	23.94	101.56	-36.49	43.22	-3.68	-36.23
1.6	-3.94	-82.00	23.62	97.75	-36.09	41.87	-3.75	-38.50
1.7	-4.20	-85.49	23.30	94.08	-35.71	40.52	-3.82	-40.77
1.8	-4.44	-88.85	22.98	90.52	-35.35	39.18	-3.89	-43.05
1.9	-4.68	-92.07	22.67	87.06	-35.01	37.83	-3.95	-45.35
2	-4.91	-95.19	22.37	83.70	-34.68	36.48	-4.01	-47.66
2.1	-5.13	-98.19	22.08	80.43	-34.37	35.13	-4.06	-50.00
2.2	-5.33	-101.10	21.79	77.22	-34.07	33.76	-4.11	-52.37
2.3	-5.53	-103.92	21.51	74.09	-33.79	32.38	-4.16	-54.77
2.4	-5.72	-106.64	21.23	71.01	-33.51	30.99	-4.21	-57.21
2.5	-5.90	-109.29	20.96	67.99	-33.25	29.58	-4.25	-59.68
2.6	-6.07	-111.86	20.70	65.02	-32.99	28.15	-4.29	-62.20
2.7	-6.24	-114.35	20.45	62.08	-32.74	26.70	-4.33	-64.75
2.8	-6.39	-116.78	20.20	59.19	-32.50	25.23	-4.37	-67.36
2.9	-6.54	-119.14	19.95	56.32	-32.27	23.75	-4.40	-70.00
3	-6.68	-121.43	19.72	53.49	-32.04	22.24	-4.43	-72.69
3.2	-6.94	-125.84	19.25	47.89	-31.62	19.15	-4.48	-78.22
3.4	-7.18	-130.02	18.81	42.36	-31.21	15.98	-4.52	-83.94
3.6	-7.39	-133.98	18.38	36.90	-30.84	12.71	-4.54	-89.84
3.8	-7.58	-137.73	17.96	31.47	-30.49	9.35	-4.55	-95.93
4	-7.75	-141.28	17.55	26.07	-30.17	5.91	-4.54	-102.19
4.5	-8.09	-149.25	16.55	12.63	-29.48	-3.07	-4.42	-118.46
5	-8.31	-156.00	15.57	-0.76	-28.97	-12.49	-4.16	-135.27
5.5	-8.41	-161.61	14.56	-14.09	-28.62	-22.23	-3.79	-152.09
6	-8.35	-166.31	13.52	-27.29	-28.46	-32.12	-3.34	-168.39

**Note : Measurement reference planes are the QFN Package Leads, a TRL calibration method is used.**

**NOISE-PARAMETERS**
 $V_D = 4 \text{ V}; I_D = 50 \text{ mA}; T_{\text{amb}} = + 23 \text{ }^\circ\text{C}.$ 

Frequency (GHz)	NF <sub>min</sub> (dB)	$ \Gamma_{\text{opt}} $	Ang $\Gamma_{\text{opt}}$ (°)	R <sub>n0</sub>
0.10	0.19	0.94	4.09	0.13
0.20	0.20	0.91	6.73	0.10
0.30	0.21	0.88	9.34	0.10
0.40	0.22	0.85	11.97	0.09
0.50	0.23	0.82	14.62	0.09
0.60	0.24	0.79	17.29	0.09
0.70	0.26	0.77	19.98	0.09
0.80	0.27	0.74	22.68	0.08
0.90	0.28	0.71	25.41	0.08
1.00	0.29	0.69	28.17	0.08
1.10	0.31	0.67	30.95	0.08
1.20	0.32	0.64	33.76	0.08
1.30	0.33	0.62	36.61	0.08
1.40	0.34	0.60	39.48	0.08
1.50	0.36	0.58	42.40	0.08
1.60	0.37	0.56	45.35	0.08
1.70	0.38	0.54	48.34	0.07
1.80	0.39	0.53	51.37	0.07
1.90	0.41	0.51	54.45	0.07
2.00	0.42	0.50	57.56	0.07
2.10	0.43	0.48	60.72	0.07
2.20	0.44	0.47	63.92	0.07
2.30	0.46	0.45	67.17	0.07
2.40	0.47	0.44	70.46	0.07
2.50	0.48	0.43	73.78	0.07
2.60	0.49	0.42	77.15	0.06
2.70	0.51	0.41	80.54	0.06
2.80	0.52	0.40	83.97	0.06
2.90	0.53	0.39	87.43	0.06
3.00	0.54	0.39	90.90	0.06
3.20	0.57	0.37	97.90	0.06
3.40	0.59	0.36	104.90	0.05
3.60	0.62	0.35	111.87	0.05
3.80	0.64	0.35	118.75	0.05
4.00	0.67	0.35	125.48	0.05
4.50	0.72	0.35	141.42	0.04
5.00	0.78	0.36	155.77	0.04
5.50	0.84	0.37	168.47	0.04
6.00	0.89	0.39	179.63	0.04

**Note : The reference planes are the QFN Package Leads.**  
**R<sub>n0</sub> is the Noise Resistance normalised to 50 Ω.**

**SINGLE ENDED REFERENCE BOARD 1900 MHz**


*Bill of materials*

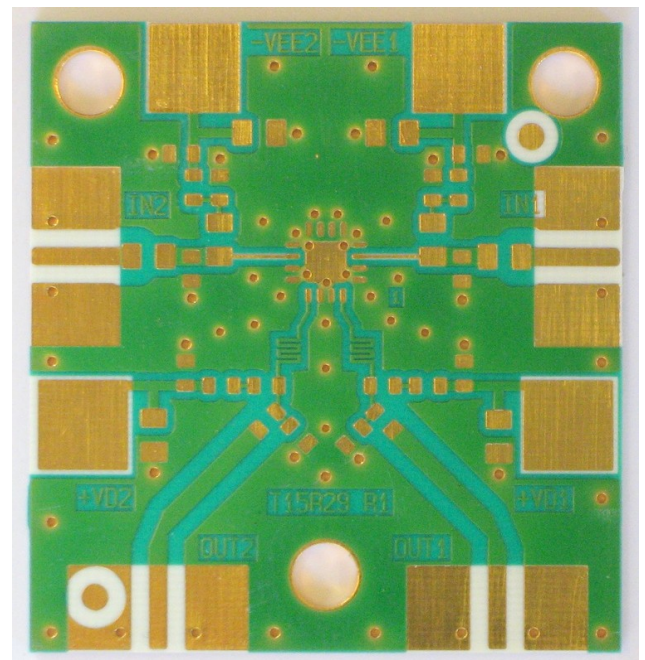
Component	Value	Reference
R1, R3	470 $\Omega$	0603
R2, R4	22 $\Omega$	0603
L1, L3	22 nH	Coilcraft 0805CS
L2, L4	22 nH	Toko 0603
C1, C8	47 pF	0603 C0G
C2, C9	10 pF	0603 C0G
C3, C10	15 pF	0603 C0G
C4, C11, C7, C14	10 nF	0805
C5, C12, C6, C13	100 pF	0603 C0G
C15, C16	47 $\mu$ F	1210 X5R
TRL1, TRL3		W=150 $\mu$ m l=3000 $\mu$ m
TRL2, TRL4		W=150 $\mu$ m l=10 000 $\mu$ m

**Notes:**

Capacitors C17 and C18 prevent low frequency oscillations when the board is biased from laboratory power supplies. They are not required when on-board voltage regulators are used.

Board material is Rogers RO4350 with height 508  $\mu$ m.

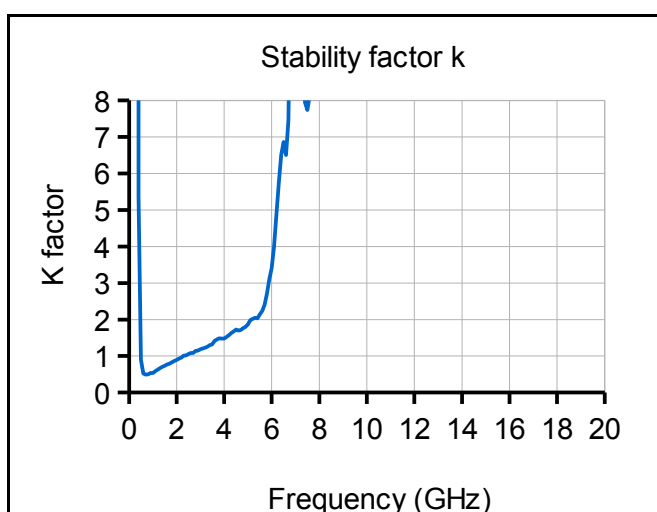
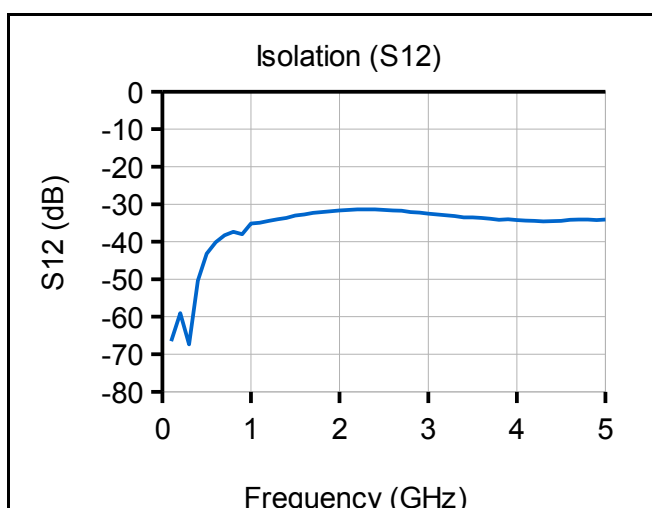
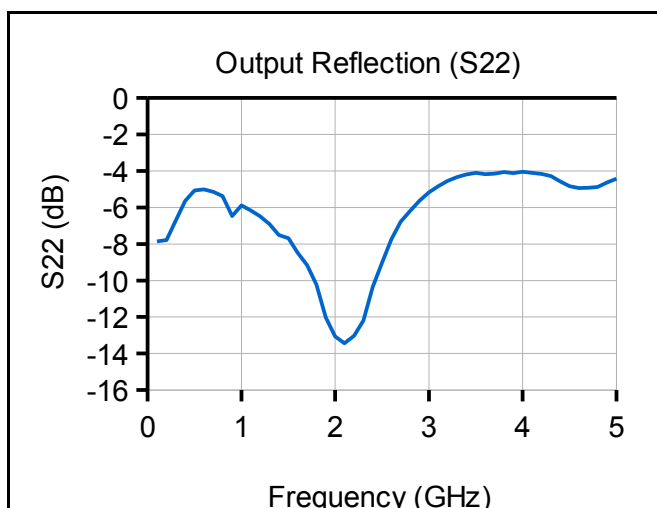
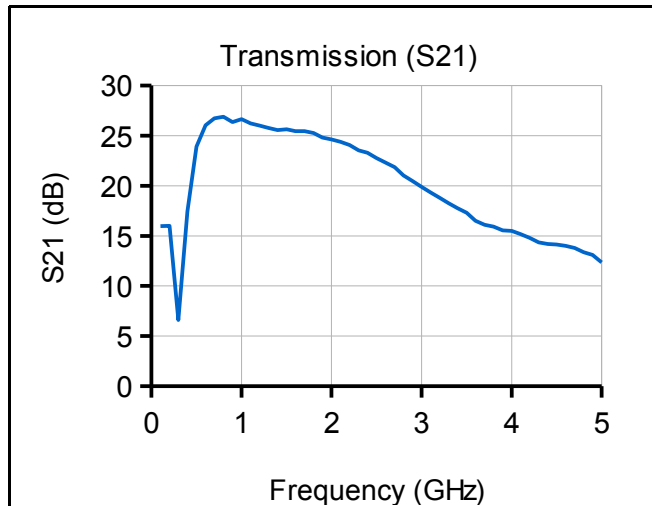
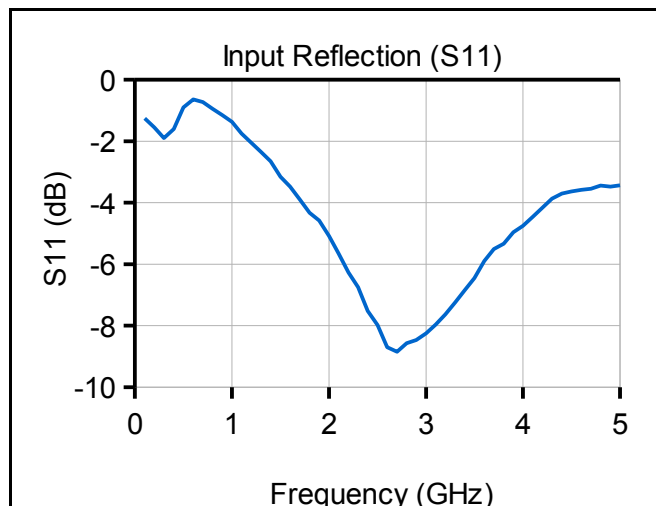
*Printed Circuit Board*

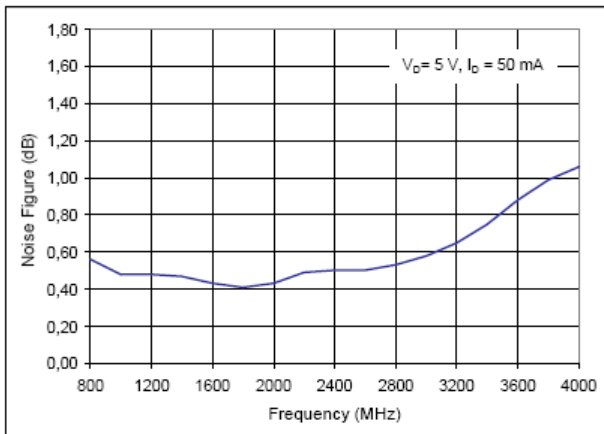
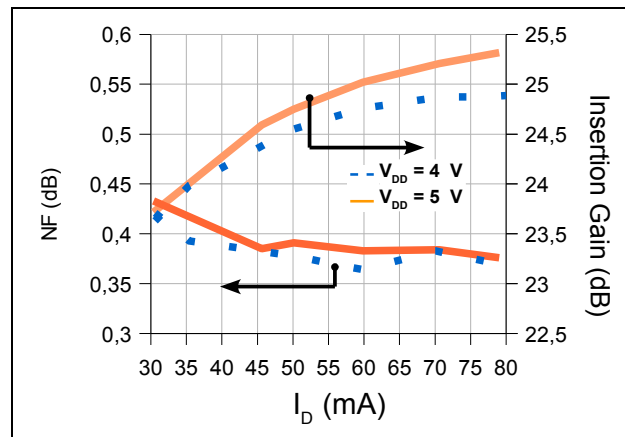
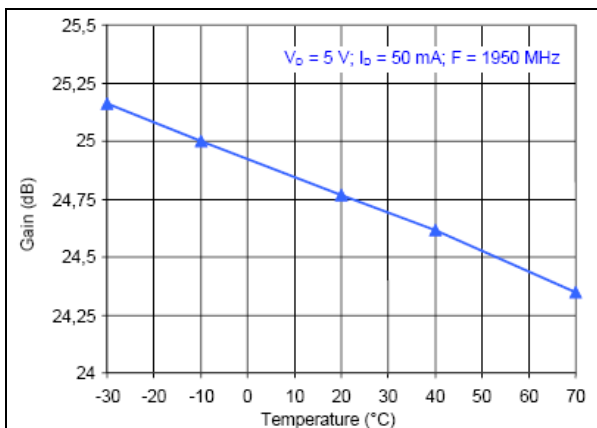
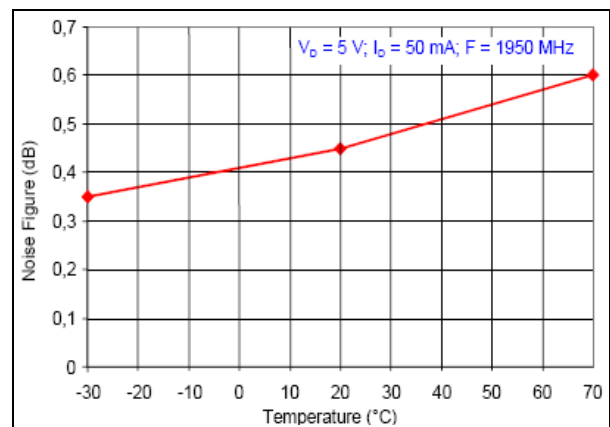


## MEASURED PERFORMANCE OF REFERENCE BOARD 1900 MHz

Conditions :  $V_{DD1} = V_{DD2} = 5\text{ V}$ ,  $I_{D1} + I_{D2} = 100\text{ mA}$ ;  $T_{amb} = +23^{\circ}\text{C}$ , unless otherwise stated.

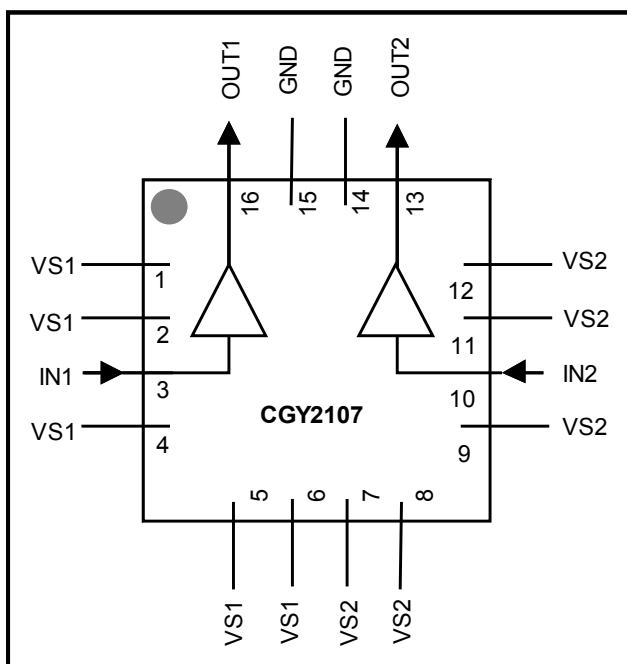
Measurements include RF connector contributions.



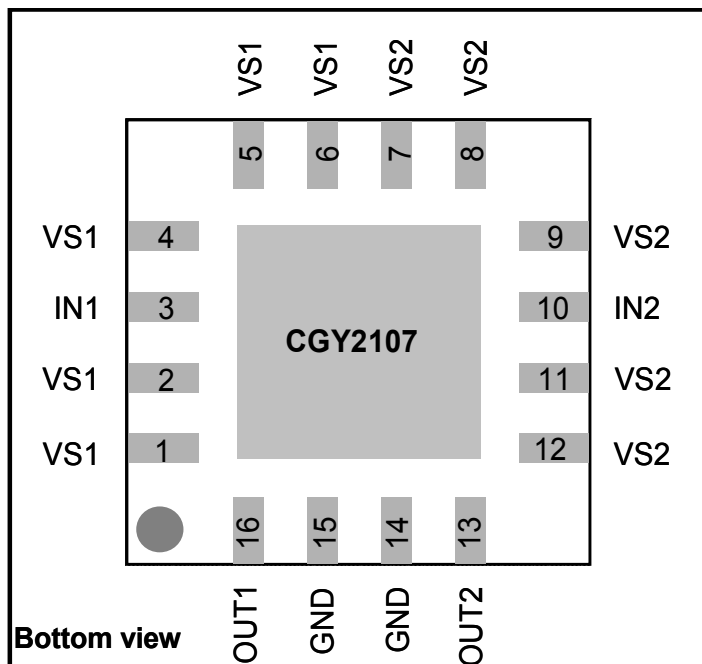
**NF versus Frequency**

**NF versus  $I_D$  current at 1900MHz**

**Gain versus Temperature**

**NF versus Temperature**

**Note :**

These results have been obtained on a Single Ended Reference Board optimised at 1950 MHz. Excellent results have been reached in balanced configuration. The frequency range of the Balanced Configuration is mainly determined by the couplers used - the CGY2107HV can be used up to 6 GHz, in balanced or single ended applications, with excellent results. For more details on the reference board used, please refer to CGY2107HV application notes.

## BLOCK DIAGRAM AND PIN CONFIGURATION



Block Diagram of the LNA CGY2107HV.



Pin Diagram of the LNA CGY2107HV.

## PINNING

Symbol	Pin	Description
VS1	1, 2, 4, 5 and 6	Amplifier 1 : Source
IN1	3	Amplifier 1 : Gate (RF input)
OUT1	16	Amplifier 1 : Drain (RF output)
VS2	7, 8, 9, 11 and 12	Amplifier 1 : Source
IN2	10	Amplifier 2 : Gate (RF input)
OUT2	13	Amplifier 2 : Drain (RF output)
GND	14 and 15	Ground

### Note :

It is essential in order to ensure good performance and stability that the central ground pad of the QFN package is suitably connected to the ground.

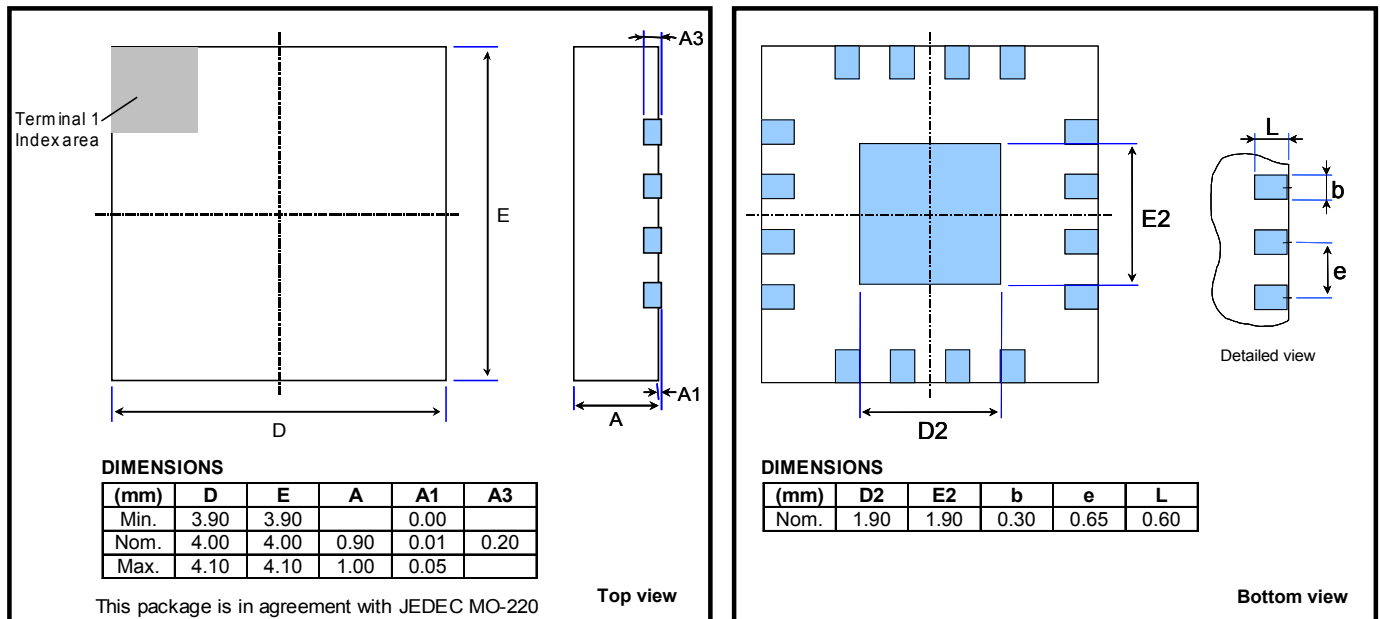


## PACKAGE

Type	Description	Terminals	Pitch (mm)	Package size (mm)
QFN	Quad Flat No lead with exposed heat sink	16	0.65	4 x 4 x 0.9

In agreement with JEDEC MO-220.

## PACKAGE OUTLINE AND PCB LAND PATTERN



## ORDERING INFORMATION

Generic type	Package type	Version	Sort Type	Description
CGY2107	HV	C1		DUAL LNA, QFN Plastic Package
CGY2107	HV	C1	REFBOARD	Single Ended Reference Board 1900MHz
CGY2107	HV	C1	BALBOARD	Balanced Reference Board 1900MHz



**THE CGY2107HV IS ROHS COMPLIANT.**

## DEFINITIONS

### Limiting values definition

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

### Application information

Applications that are described herein for any of these products are for illustrative purposes only. OMMIC makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

## DISCLAIMERS

### Life support applications

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